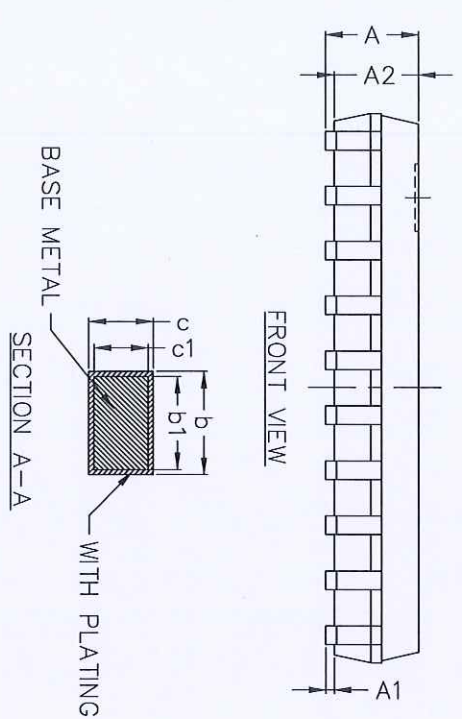


	SYMBOL	MIN	NOM	MAX
TOTAL THICKNESS	A	-	-	1.20
STAND OFF	A1	0.05	0.100	0.15
MOLD TOTAL THICKNESS	A2	0.90	1.00	1.05
LEAD WIDTH-1	b	0.20	-	0.28
LEAD WIDTH-2	b1	0.19	0.22	0.25
LEAD THICKNESS-1	c	0.13	-	0.17
LEAD THICKNESS-2	c1	0.120	0.127	0.14
MOLD LENGTH	D	6.40	6.50	6.60
LEAD SPAN	E	6.20	6.40	6.60
MOLD WIDTH	E1	4.30	4.40	4.50
LEAD PITCH	e	0.65 BSC		
LEAD LENGTH	L1	0.85	1.00	1.15
LEAD SOLE LENGTH	L	0.45	0.60	0.75
LEAD FORM ANGLE	theta	0°	-	8°



REV	A	INITIAL ISSUE	黄乙为	2022/07/20
REV	DESCRIPTION OF CHANGE			
TITLE	TSSOP20 POD			
DWG No.	C-0L-162	MATERIAL		
REV	A	SHEET	1/1	DWN
X.X		SCALE	NTS	CKD
X.XX		UNIT	MM	APPD
X.XXX				
		气派科技 Chippacking		
		DRAWER	黄乙为	ISSUE DATE
			2022/07/20	
			2022/07/20	